

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Michael S. Leung Confirmation No. 8955
Serial No.: 10/666,399 Examiner: Abul Kalam
Filed: September 18, 2003 Art Unit: 2814
Docket No. P0298US-7 Customer No. 23935

Title: MOLDED CHIP FABRICATION METHOD AND APPARATUS

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REPLY TO OFFICE ACTION

Sir:

In response to the Office Action mailed on May 11, 2010, please enter the amendments and consider the remarks and arguments presented herein.

AMENDMENTS TO THE CLAIMS are reflected in the Listing of the Claims which begins on page 2 of this paper.

REMARKS begin on page 12 of this paper.